



# **SDM20U40**

### SURFACE MOUNT SCHOTTKY BARRIER DIODE

# **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Reverse Capacitance
- Ultra-Small Surface Mount Package
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device, Note 3 and 4
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

Case: SOD-523

 Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0



Terminal Connections: Cathode Band

 Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208

Marking Code: S4

Ordering Information: See Last Page
 Weight: 0.002 grams (approximate)

# CATHODE MARK MARKING CODE CATHODE MARK

SOD-523						
Dim	Dim Min					
Α	1.50	1.70				
В	1.10	1.30				
С	0.25	0.35				
D	0.70	0.90				
Ec.	0.10	0.20				
G	0.55	0.65				
All Dimensions in mm						

### **Maximum Ratings** @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Value	Unit		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		40			
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V		
Forward Continuous Current (Note 2)	I <sub>FM</sub>	250	mA		
Non-Repetitive Peak Forward Surge Current @ t ≤ 1.0s	I <sub>FSM</sub>	1.0	Α		
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +125	°C		

# Thermal Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P <sub>d</sub>	150	mW
Thermal Resistance, Junction to Ambient Air (Note 2)	$R_{\theta JA}$	667	°C/W

Note: 1. No purposefully added lead.

- Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- 4. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

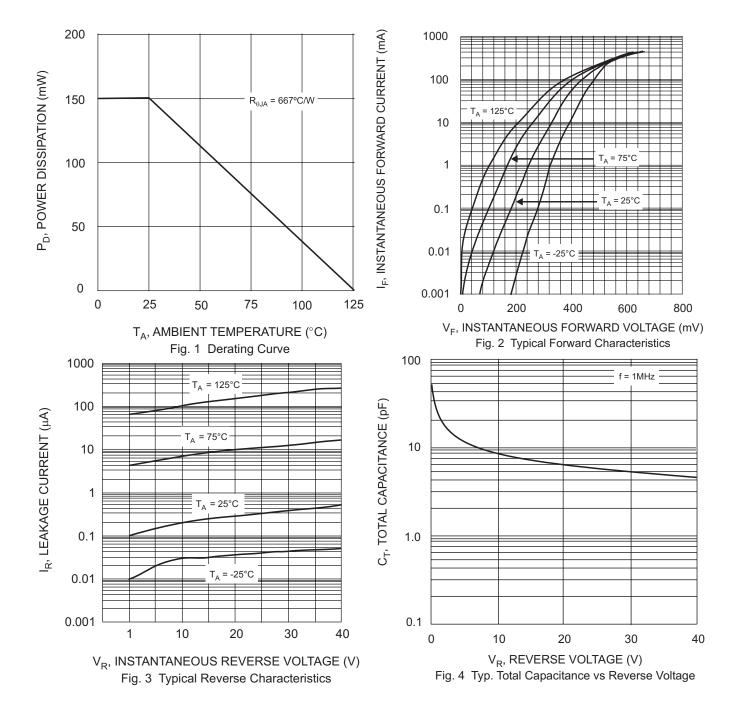




<b>Flectrical</b>	Characteristics	@ T <sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 5)	V <sub>(BR)R</sub>	40	_	_	V	$I_R = 10\mu A$
Forward Voltage Drop	VF	_	_	0.37 0.60	V	I <sub>F</sub> = 20mA I <sub>F</sub> = 200mA
Peak Reverse Current (Note 5)	I <sub>R</sub>	_	_	5 1	μ <b>Α</b> μ <b>Α</b>	V <sub>R</sub> = 30V V <sub>R</sub> = 10V
Total Capacitance	C <sub>T</sub>	_	50	_	pF	V <sub>R</sub> = 0V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	10	_	ns	$I_F = I_R = 200 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Note: 5. Short duration pulse test used so as to minimize self-heating effect.





# Ordering Information (Note 4 & 6)

Device	Packaging	Shipping		
SDM20U40-7	SOD-523	3000/Tape & Reel		

Note: 4. Product manufactured with date code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

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